# 2.5V Drive Nch+SBD MOSFET **US6U37**

#### Structure

Silicon N-channel MOSFET/ Schottky barrier diode

#### Features

- 1) Nch MOSFET and schottky barrier diode are put in TUMT6 package.
- 2) High-speed switching, Low On-resistance.
- 3) Low voltage drive (2.5V drive).
- 4) Built-in Low VF schottky barrier diode.

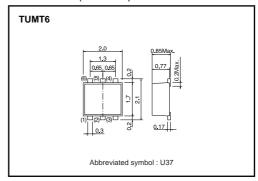
## Applications

Switching

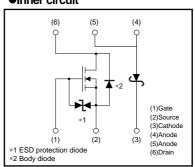
### Package specifications

	Package	Taping
Туре	Code	TR
	Basic ordering unit (pieces)	3000
US6U37		0

#### ● **Dimensions** (Unit: mm)



#### •Inner circuit



# ● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter		Symbol	Limits	Unit
Drain-source voltage		V <sub>DSS</sub>	30	V
Gate-source voltage		Vgss	±12	V
Dania assessat	Continuous	ΙD	±1.5	А
Drain current	Pulsed	I <sub>DP</sub> *1	±6.0	A
Source current	Continuous	Is	0.6	A
(Body diode)	Pulsed	I <sub>SP</sub> *1	6.0	А
Channel temperature		Tch	150	°C
Power dissipation		P <sub>D</sub> *2	0.7	W / ELEMENT

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1% \*2 Mounted on a ceramic board

<Di>

NDI2				
Parameter	Symbol	Limits	Unit	
Repetitive peak reverse voltage	V <sub>RM</sub>	25	V	
Reverse voltage	VR	20	V	
Forward current	lF	0.7	А	
Forward current surge peak	IFSM *1	10	A	
Junction temperature	Tj	150	°C	
Power dissipation	P <sub>D</sub> *2	0.5	W / ELEMENT	

<sup>\*1 60</sup>Hz • 1cycle \*2 Mounted on ceramic board

# <MOSFET and Di>

Parameter	Symbol	Limits	Unit	
Power dissipation	P <sub>D</sub> *1	1.0	W / TOTAL	
Range of storage temperature	Tstg	-55 to +150	°C	

<sup>\*1</sup> Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

## <MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	_	±10	μΑ	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR) DSS	30	1	-	V	ID= 1mA, VGS=0V
Zero gate voltage drain current	IDSS	1	-	1	μΑ	V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	0.5	-	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Otation Lastin and Automatical		_	170	240	mΩ	I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 4.5V
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	_	180	250	mΩ	I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 4V
resistance		_	240	340	mΩ	ID= 1.5A, VGS= 2.5V
Forward transfer admittance	Y <sub>fs</sub>   *	1.5	_	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1.5A
Input capacitance	Ciss	1	80	-	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	14	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	_	7	_	ns	V <sub>DD</sub> ≒ 15V
Rise time	tr *	_	9	_	ns	ID= 0.75A
Turn-off delay time	t <sub>d (off)</sub> *	_	15	_	ns	V <sub>GS</sub> = 4.5V R <sub>L</sub> ≒ 20Ω
Fall time	t <sub>f</sub> *	_	6	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	-	1.6	2.2	nC	V <sub>DD</sub> ≒15V, V <sub>GS</sub> =4.5V
Gate-source charge	Q <sub>gs</sub> *		0.5	_	nC	I <sub>D</sub> = 1.5A
Gate-drain charge	Q <sub>gd</sub> *	_	0.3	-	nC	R <sub>L</sub> ≒10Ω, R <sub>G</sub> =10Ω

\*Pulsed

## <Body diode characteristics (Source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	1	_	1.2	٧	I <sub>S</sub> = 0.6A, V <sub>GS</sub> =0V

# <Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	-	_	0.49	V	I <sub>F</sub> = 0.7A
Reverse current	lR	_	_	200	μΑ	V <sub>R</sub> = 20V

#### Electrical characteristics curves

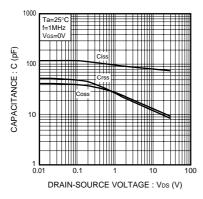


Fig.1 Typical Capacitance vs. Drain-Source Voltage

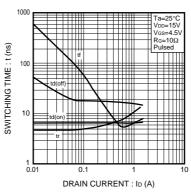


Fig.2 Switching Characteristics

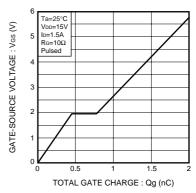


Fig.3 Dynamic Input Characteristics

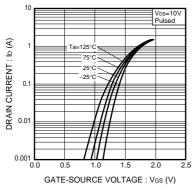


Fig.4 Typical Transfer Characteristics

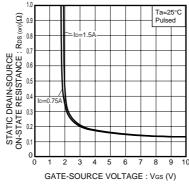


Fig.5 Static Drain-Source On-State Resistance vs. Gate source Voltage

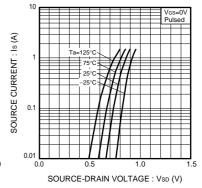


Fig.6 Source Current vs. Source-Drain Voltage

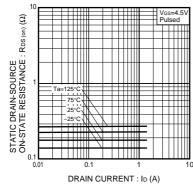


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current ( I )

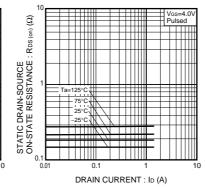


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current ( II )

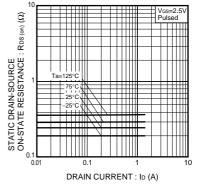
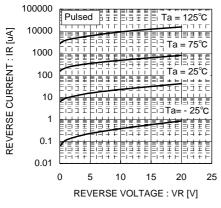


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current ( III )



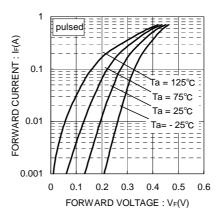


Fig.10 Reverse Current vs. Reverse

Fig.11 Forward Current vs. Forward Voltage

#### Measurement circuit

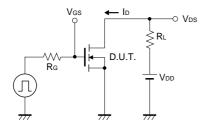


Fig.12 Switching Time Test Circuit

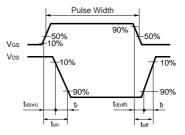


Fig.13 Switching Time Waveforms

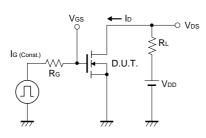


Fig.14 Gate Charge Measurement Circuit

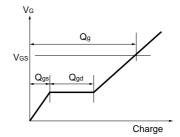


Fig.15 Gate Charge Waveform

#### ●Notice

- SBD has a large reverse leak current compared to other type of diode. Therefore; it would raise a junction temperature, and increase a reverse power loss. Further rise of inside temperature would cause a thermal runaway.
   This built-in SBD has low V<sub>F</sub> characteristics and therefore, higher leak current. Please consider enough the surrounding temperature, generating heat of MOSFET and the reverse current.
- 2. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

#### Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any
  means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the
  product described in this document are for reference only. Upon actual use, therefore, please request
  that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard
  use and operation. Please pay careful attention to the peripheral conditions when designing circuits
  and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or
  otherwise dispose of the same, no express or implied right or license to practice or commercially
  exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

It is our top priority to supply products with the utmost quality and reliability. However, there is always a chance of failure due to unexpected factors. Therefore, please take into account the derating characteristics and allow for sufficient safety features, such as extra margin, anti-flammability, and fail-safe measures when designing in order to prevent possible accidents that may result in bodily harm or fire caused by component failure. ROHM cannot be held responsible for any damages arising from the use of the products under conditions out of the range of the specifications or due to non-compliance with the NOTES specified in this catalog.

Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact your nearest sales office.

**ROHM** Customer Support System

THE AMERICAS / EUROPE / ASIA / JAPAN

www.rohm.com

Contact us : webmaster@rohm.co.jp

Copyright © 2008 ROHM CO.,LTD.

ROHM CO., LTD. 21 Saiin Mizosaki-cho, Ukyo-ku, Kyoto 615-8585, Japan

an TEL: +81-75-311-2121 FAX: +81-75-315-0172

